

APPROVAL SHEET

RFBPF Series - 1608(0603)- RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

Halogens Free Product

2.4 GHz ISM Band RF Application

P/N: RFBPF1608060AAT

*Contents in this sheet are subject to change without prior notice.

FEATURES

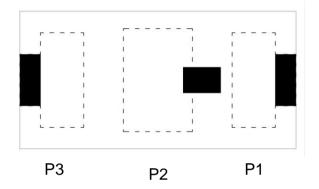
- 1. Miniature footprint: 1.6 X 0.8 X 0.6 mm³
- 2. Low Profile Thickness
- 3. Low Insertion loss
- 4. High Rejection Rate
- 5. High attenuation on 2nd harmonic suppressed
- 6. LTCC process

APPLICATIONS

- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g, HomeRF

CONSTRUCTION

Top view



PIN	Connection		
1	Input port		
2	GND		
3	Output port		

DIMENSIONS

Figure	Symbol	Dimension (mm)
	L	1.60 ± 0.15
Top view	W	0.80 ± 0.10
Side view	Т	0.65 max.
	А	0.25 ± 0.10
Bottom view " □ □ □ □ □ ≥	В	0.23 ± 0.05
C B A	С	0.40 ± 0.10
Side view	D	0.30 ± 0.15
	E	0.55 ± 0.10
	F	0.60 ± 0.10



ELECTRICAL CHARACTERISTICS

RFBPF1608060AAT	Specification
Frequency range	2400 ~ 2500
Insertion Loss	0.95 dB max. at 25 °C 1.25 dB max. at – 40 ~ + 85 °C
Attenuation	20 dB min. @ 500 ~ 960MHz 23 dB min. @ 3200 MHz 30 dB min. @ 4800 ~ 5000MHz 32 dB min. @ 7200 ~ 7500MHz
VSWR	2.0 max.
Impedance	50Ω
Power Capacity	2W max.
Moisture sensitivity levels	MSL is LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)

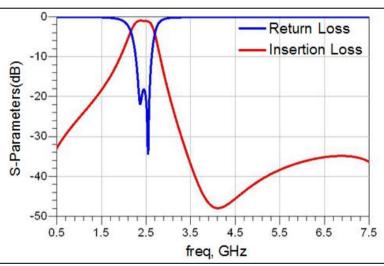
Operating & Storage Condition (Component)

Operation Temperature Range: -40 ~ +85 ℃ Storage Temperature Range: -40 ~ +85 °C

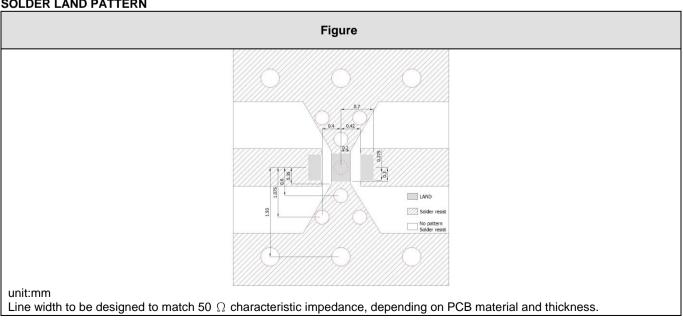
Storage Condition before Soldering (Included packaging material)

Storage Temperature Range: +5 ~ +40 ℃ Humidity: 30 to 70% relative humidity

Typical Electrical Chart



SOLDER LAND PATTERN



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RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature: 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature: 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 ± 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	electrode shall not exceed 25%.
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature: 120~150°C,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
	IIIIIIOISIOIT IIIIO - TOET SCO	~ 85°C.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	electrode shall not exceed 25%.
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044 Customer's specification.	*Test Surface: Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85°C.
) (I		
Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude: 1.5mm	Electrical specification shall satisfy the
	*Test times: 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85°C.
Adhooiya Ctronoth		
Adhesive Strength of Termination	*Pressurizing force :	No remarkable damage or removal of the
JIS C 0051- 7.4.3	5N(≤0603); 10N(>0603)	termination.
313 0 0031- 7.4.3	*Test time: 10±1 sec	
Bending test	The middle part of substrate shall be	No mechanical damage.
JIS C 0051- 7.4.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	



±3 minutes at -40°C±3°C, ~15 minutes at room temperature, ±3 minutes at +85°C±3°C, ~15 minutes at room temperature, 00 continuous cycles rement to be made after keeping at emperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
perature: 85°C±2°C duration: 1000+24/-0 hours become to be made after keeping at the emperature for 24±2 hrs dity: 90% to 95% R.H. become to be made after keeping at the emperature: 40±2°C : 1000+24/-0 hrs. become to be made after keeping at the emperature at the	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
coom temperature for 24±2 hrs whrs measuring the first data then 000hrs data Derature: -40°C±2°C duration: 1000+24/-0 hours rement to be made after keeping at emperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
	~15 minutes at room temperature, ±3 minutes at +85°C±3°C, ~15 minutes at room temperature, 00 continuous cycles rement to be made after keeping at emperature for 24±2 hrs Derature: 85°C±2°C duration: 1000+24/-0 hours rement to be made after keeping at emperature for 24±2 hrs dity: 90% to 95% R.H. Derature: 40±2°C :: 1000+24/-0 hrs. Tement to be made after keeping at room temperature for 24±2 hrs hrs measuring the first data then 100hrs data Derature: -40°C±2°C duration: 1000+24/-0 hours rement to be made after keeping at room temperature for 24±2 hrs hrs measuring the first data then 100hrs data



SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

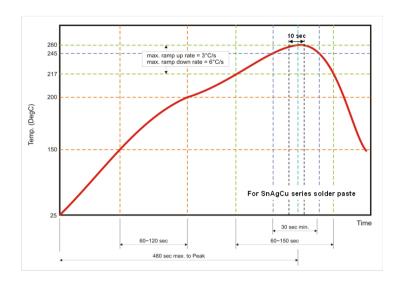


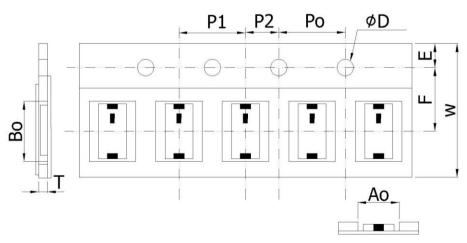
Fig 2. Infrared soldering profile

ORDERING CODE

RF	BPF	160806	0	Α	Α	Т
Walsin	Product Code	Dimension code Unit of		Applications	Specification	Package
RF	BPF:	Per 2 digits of Length, Width,	dimension	A: 2.4GHz ISM	Design code	T :
device	Band Pass Filter	Thickness :	0 : 0.1 mm	Band		Reeled
		e.g. :	1 : 1.0 mm			
		160806 =				
		Length 16,				
		Width 08, Thickness 06				

Minimum Ordering Quantity: 4000 pcs per reel.

PACKAGING

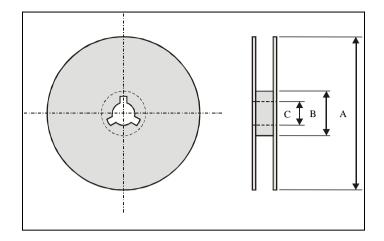


Paper Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	0.975 ± 0.10	1.76 ± 0.10	1.55 + 0.05	0.75 ± 0.10	8.0 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05



Reel dimensions



Index	А	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity: 4000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

■ Temperature : +5 to +40°C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.

单击下面可查看定价,库存,交付和生命周期等信息

>>Walsin Technology(华新科技)